

STY80NM60N

N-channel 600 V, 0.030 Ω 74 A, MDmesh™ II Power MOSFET Max247

Features

Туре	V _{DSS} @ T _{Jmax}	R _{DS(on)} max	I _D
STY80NM60N	650 V	< 0.035 Ω	74 A

- The worldwide best R_{DS(on)} in Max247
- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance



■ Switching applications

Description

This device is an N-channel Power MOSFET developed using the second generation of MDmesh™ technology. This revolutionary Power MOSFET associates a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.

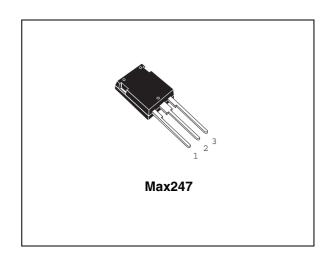


Figure 1. Internal schematic diagram

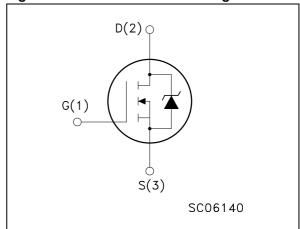


Table 1. Device summary

Order code	Marking	Package	Packaging	
STY80NM60N	STY80NM60N 80NM60N		Tube	

Contents STY80NM60N

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STY80NM60N Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	600	V
V _{GS}	Gate- source voltage	±25	٧
I _D	Drain current (continuous) at T _C = 25 °C	74	Α
I _D	Drain current (continuous) at T _C = 100 °C	46	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	296	Α
P _{TOT}	Total dissipation at T _C = 25 °C	447	W
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
T _{stg}	Storage temperature	-55 to 150	°C
T _j	Max. operating junction temperature	150	°C

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.28	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	30	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AS}	Avalanche current, repetitive or not-repetitive (pulse width limited by Tj Max)	25	Α
E _{AS}	Single pulse avalanche energy (starting Tj = 25°C, I _D = I _{AS} , V _{DD} = 50 V)	2	J

^{2.} $I_{SD} \leq 74 \text{ A, di/dt} \leq 400 \text{ A/µs, } V_{DSpeak} \leq V_{(BR)DSS,} V_{DD} = 80\% V_{(BR)DSS}$

Electrical characteristics STY80NM60N

2 Electrical characteristics

(T_{CASE}=25 °C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage (V _{GS} = 0)	I _D = 1 mA	600			٧
dv/dt (1)	Drain source voltage slope	$V_{DD} = 480 \text{ V}, I_{D} = 74 \text{ A},$ $V_{GS} = 10 \text{ V}$		48		V/ns
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = max rating V_{DS} = max rating, T_{C} = 125 °C			10 100	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_D = 37 \text{ A}$		0.030	0.035	Ω

^{1.} Characteristic value at turn off on inductive load.

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	V _{DS} =15 V _, I _D = 37 A		12		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 50 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$		10100 455 26		pF pF pF
Coss eq. (2)	Equivalent output capacitance	V _{GS} = 0, V _{DS} = 0 to 480 V		1300		pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} = 480 V, I_D = 74 A, V_{GS} = 10 V, (see Figure 15)		360 85 160		nC nC nC
R _g	Gate input resistance	f=1 MHz Gate DC Bias=0 Test signal level = 20 mV open drain		2.0		Ω

^{1.} Pulsed: Pulse duration = 300 μs, duty cycle 1.5%

^{2.} $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DS}

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$\begin{matrix} t_{\rm d(on)} \\ t_{\rm r} \\ t_{\rm d(off)} \\ t_{\rm f} \end{matrix}$	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD} = 300 \text{ V}, I_{D} = 37 \text{ A}$ $R_{G} = 4.7 \Omega V_{GS} = 10 \text{ V}$ (see Figure 14)		50 65 440 200		ns ns ns ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current				74	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				296	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 74 A, V _{GS} = 0			1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 74 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		700		ns
Q_{rr}	Reverse recovery charge	V _{DD} = 100 V, T _i = 25 °C		25		μC
I _{RRM}	Reverse recovery current	(see Figure 16)		65		Α
t _{rr}	Reverse recovery time	$I_{SD} = 74 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		840		ns
Q_{rr}	Reverse recovery charge	$V_{DD} = 100 \text{ V}, T_j = 150 ^{\circ}\text{C}$		30		μC
I _{RRM}	Reverse recovery current	(see Figure 16)		69		Α

^{1.} Pulse width limited by safe operating area .

^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STY80NM60N

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

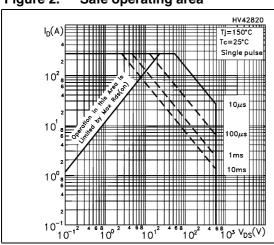


Figure 3. Thermal impedance

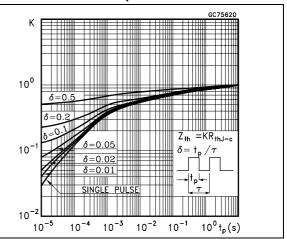


Figure 4. Output characteristics

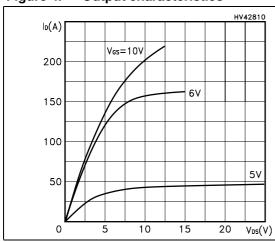


Figure 5. Transfer characteristics

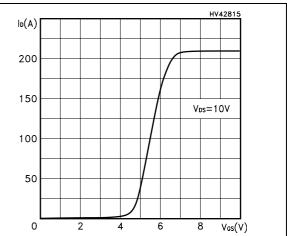


Figure 6. Transconductance

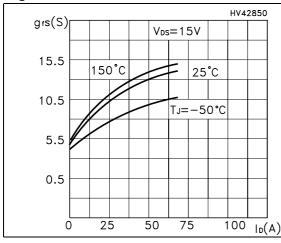


Figure 7. Static drain-source on resistance

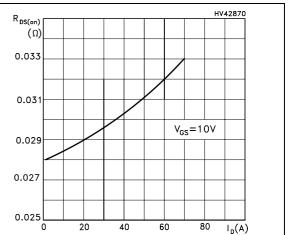


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

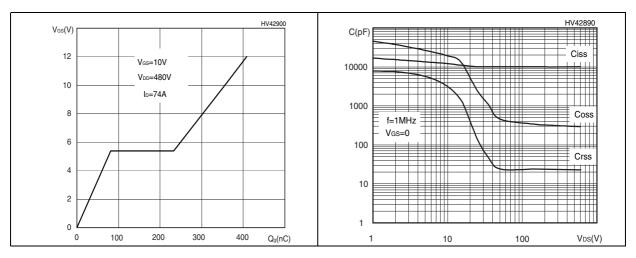


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

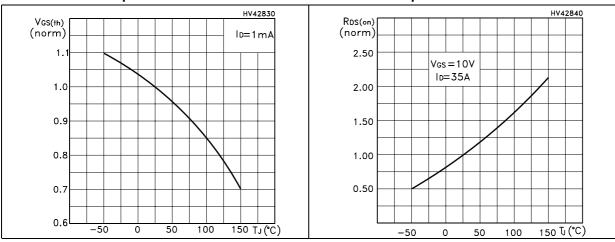
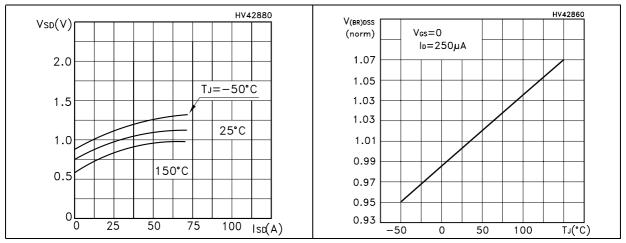


Figure 12. Source-drain diode forward characteristics

Figure 13. Normalized BV_{DSS} vs temperature



Test circuits STY80NM60N

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

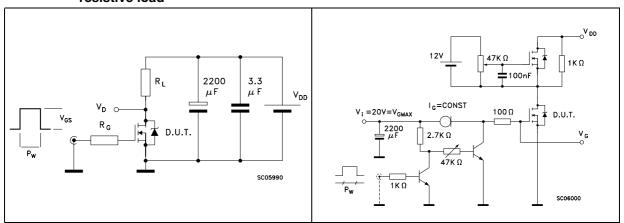


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

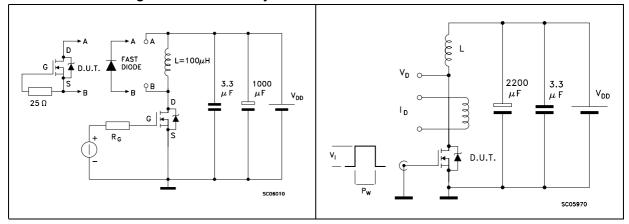
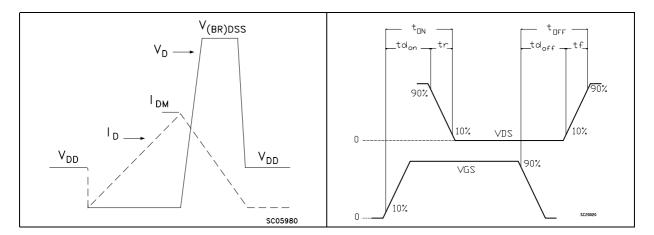


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



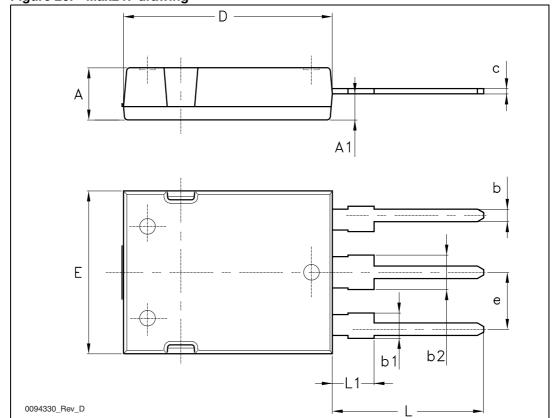
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 9. Max247 mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
А	4.70		5.30
A1	2.20		2.60
b	1.00		1.40
b1	2.00		2.40
b2	3.00		3.40
С	0.40		0.80
D	19.70		20.30
е	5.35		5.55
E	15.30		15.90
L	14.20		15.20
L1	3.70		4.30

Figure 20. Max247 drawing



STY80NM60N Revision history

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
29-Nov-2007	1	First release.
04-Dec-2007	2	Header has been corrected.
04-Aug-2008	3	Document status promoted: from preliminary data to datasheet.
14-Nov-2008	4	Figure 13: Normalized BV_{DSS} vs temperature has been corrected.
04-Feb-2009	5	Figure 7: Static drain-source on resistance has been corrected.
06-Jul-2011	6	Modified I _{DSS} value in <i>Table 5: On/off states</i> .

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